

PROJECT 38 SHOWCASE

SUNRISE HITEK



Project Name:

Digital Kiss-Cutting and Die-Cutting

Specifications:

Material: White paper & vinyl label
Clear & white static cling
Clear label and synthetic paper
Cover stock, SBS, rigid vinyl, styrene, and plastic substrates up to 2" thick

Printing: HP Indigo digital printing
2436dpi resolution, true offset quality
White ink available
Up to 20pt thick material

Finishing: UV coating and lamination
Zund G3 digital cutting

Sizes: Up to 12"x18"

Quantity: From 25 to thousands

Why We Do It Better:

- Best-in-the-business HP Indigo print quality. Prints with true CMYK inks with 5.5x resolution and 10x smaller dots compared to toner-based printers
- Opaque white ink available for printing on clear and colored substrates. White density can be precisely controlled to achieve the desired look
- Heavy substrates can be up to 20pt thick
- In-house UV coating and lamination to protect heavy ink coverage from scuffing and scratching
- Optically-registered digital cutting offers perfect registration between parts and superb edge quality.
- Super-fast turnaround

